

# Uncompensated SO-16 Pressure Sensor

## SM9D, SM9G Series

### FEATURES



- Uncompensated millivolt analog output
- Differential or gage pressure options
- Vertical or horizontal porting configurations
- Pressure ranges: 0.15, 0.6 & 1.5 PSI
- Variable supply voltage
- Built in ESD protection

### DESCRIPTION

Silicon Microstructures provides its most popular pressure sensor die in a surface mount small outline package (SO-16) configuration. All parts in this series are uncompensated high performance die mounted in a rugged plastic package designed for surface mounting.

The low pressure SM9D/G series incorporates Silicon Microstructures' unique pressure die to achieve high performance in pressure ranges of 0.15, 0.6 & 1.5 PSI full-scale in gauge and differential configurations.

Industrial	Consumer	Medical
Handheld Meters	Sports Equipment	Hospital Beds
Pneumatic Gauges	Appliances	Wound Therapy
Pressure Switches		Health Monitoring

**ABSOLUTE MAXIMUM RATING TABLE**

All parameters are specified at  $V_{DD} = 5.00$  V DC SUPPLY at 25°C, unless otherwise noted.

No.	Characteristic	Symbol	Minimum	Typical	Maximum	Units
1	Supply Voltage <sup>(a, c)</sup>	$V_{DD}$	-	-	6.5	V
2	Supply Current <sup>(a, c)</sup>	$I_{VDD}$	-	-	1.6	mA
3	Operating Temperature Range <sup>(b)</sup>	$T_{OP}$	-40	-	+85	°C
4	Storage Temperature <sup>(b)</sup>	$T_{STG}$	-40	-	+125	°C
5	ESD Voltage (HBM)	$V_{ESD}$	4	-	-	kV

**NOTES:**

- a. The device can only be driven with the supply voltage connected to the pins as shown. The positive output will increase with increasing pressure applied to the package.
- b. Tested on a sample basis.
- c. Never exceed 6.5 V supply voltage under any operating conditions.

No.	Product Number	Operating Pressure	Proof Pressure ( $P_{PROOF}$ ) <sup>(d, e)</sup>	Burst Pressure ( $P_{BURST}$ ) <sup>(d, f)</sup>
6	SM9X-BXX-X-001S-000	0.15 PSI	1.5 PSI	3.0 PSI
8	SM9X-BXX-X-006S-000	0.6 PSI	4.8 PSI	6.0 PSI
9	SM9X-BXX-X-015S-000	1.5 PSI	12.0 PSI	15.0 PSI

**NOTES:**

- d. Tested on a sample basis.
- e. Proof pressure is defined as the maximum pressure to which the device can be taken and still perform within specifications after returning to the operating pressure range.
- f. Burst pressure is the pressure at which the device suffers catastrophic failure resulting in pressure loss through the device.

### OPERATING CHARACTERISTICS TABLE

All parameters are specified at  $V_{DD} = 5.0$  V DC SUPPLY at 25°C, unless otherwise noted.

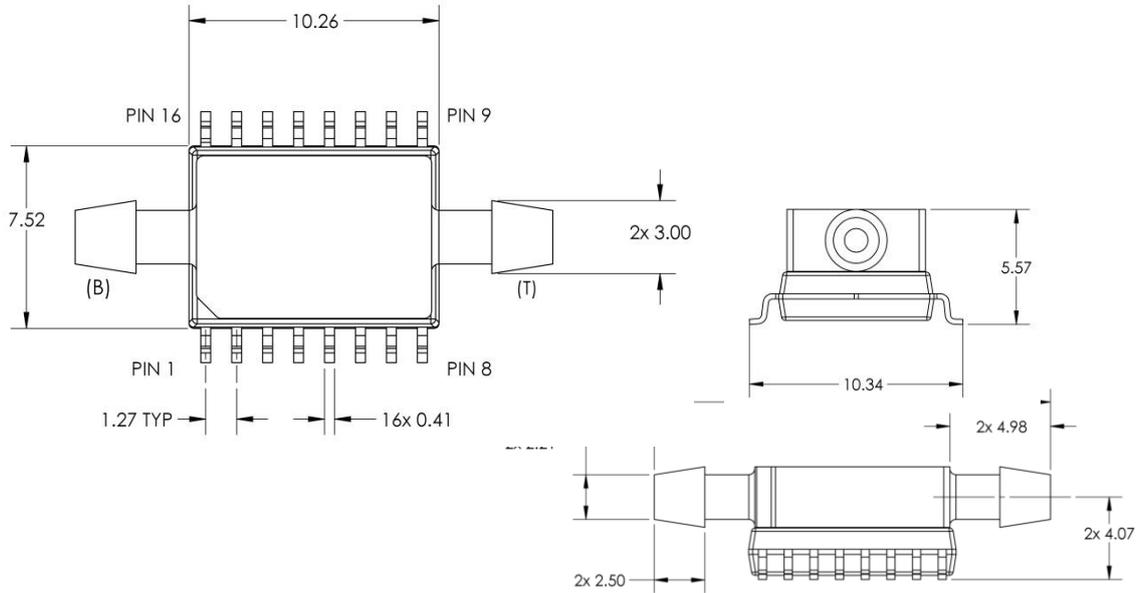
No.	Characteristic	Symbol	Minimum	Typical	Maximum	Units
10a	Span <sup>(0.15 PSI)</sup> (g)	$V_{SPAN}$	30	45	60	mV
10b	Span <sup>(0.60, 1.5 PSI)</sup> (g)		50	90	120	
11	Zero Offset	$V_{ZERO}$	-55	0	+55	mV
12	TC Span <sup>(g, i, j)</sup>	TCS	-0.24	-0.21	-0.15	%FS/°C
13	TC Zero Offset <sup>(g, i, j)</sup>	TCZ	-100	-	100	μV/°C
14	TC Resistance <sup>(h, i, j)</sup>	TCR	0.17	0.20	0.23	%R <sub>B</sub> /°C
15	Topside Linearity <sup>(g, j)</sup>	NL	-0.15	±0.1	0.15	%FS
16	Backside Linearity <sup>(g, j)</sup>		-0.35	±0.2	0.35	
17	Bridge Resistance	R <sub>B</sub>	4.0	5.0	6.0	kΩ

**Notes:**

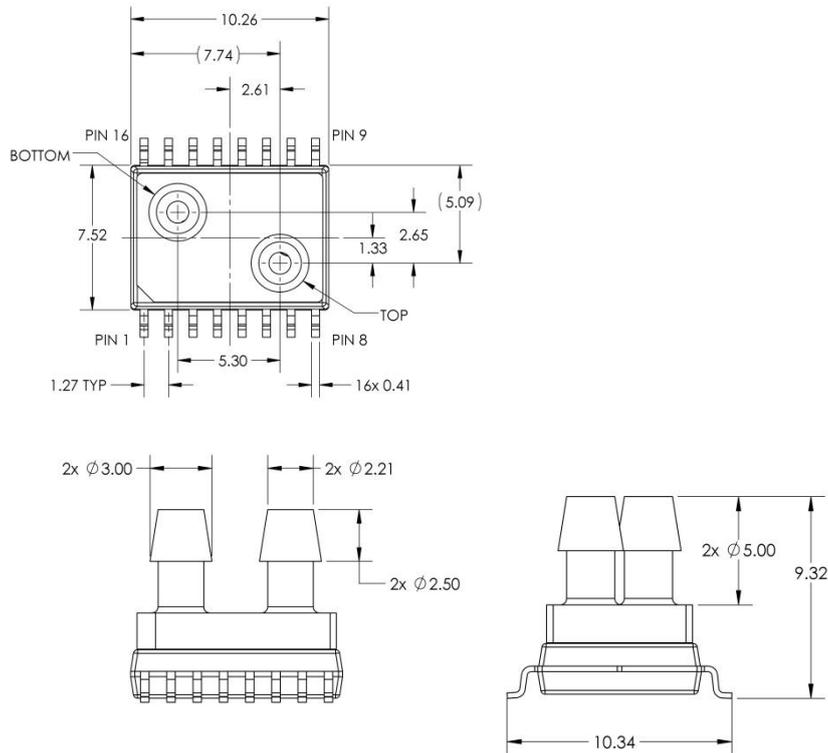
- g. Tested on a sample basis.
- h. The device can only be driven with the supply voltage connected to the pins as shown.
- i. Determined by measurements taken between -40°C and 85°C.
- j. Defined as best fit straight line.

Diagrams & Dimensions

**Dual Horizontal Porting Configuration: SM9D-BB**

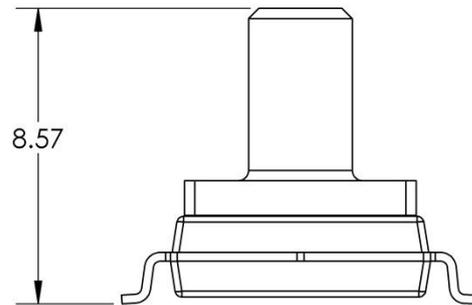
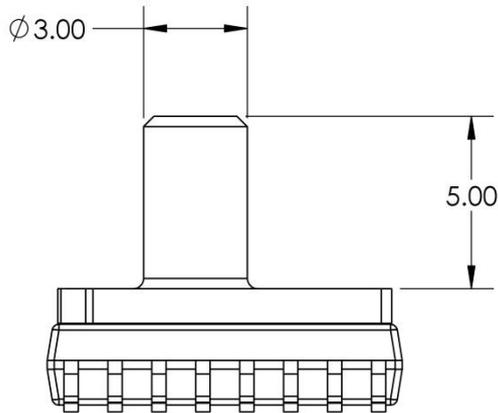
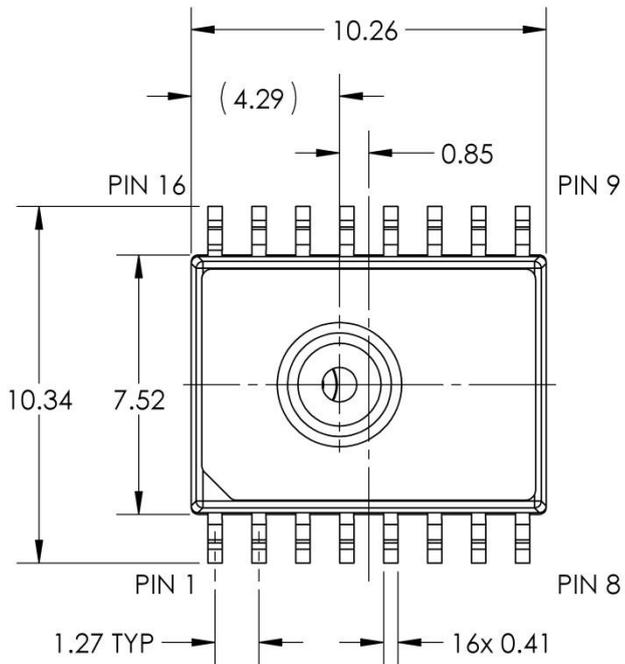


**Dual Vertical Porting Configuration: SM9D-BC**



**Notes:**

- All dimensions in units of [mm]
- Moisture Sensitivity Level (MSL): Level 3
- Positive pressure applied to the topside of the die [T] is resulting in a positive change in output.

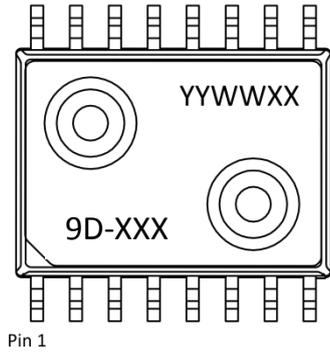


**Notes:**

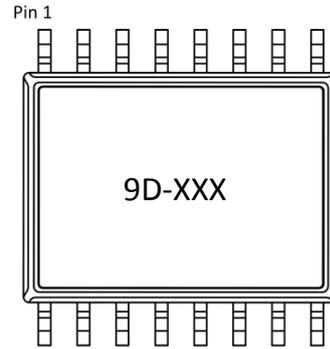
- All dimensions in units of [mm].
- Moisture Sensitivity Level (MSL): Level 3
- Positive pressure applied to the port is resulting in a positive change in output. Pressure is applied to the backside of the die.

Part & Lot Number Identification

Top View

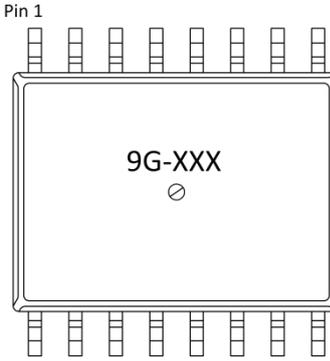
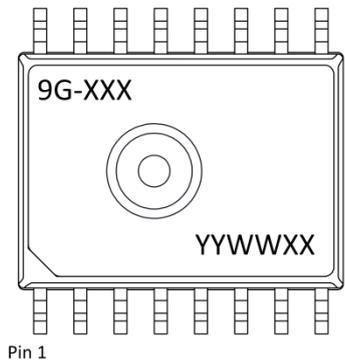


Bottom View



Pin 1

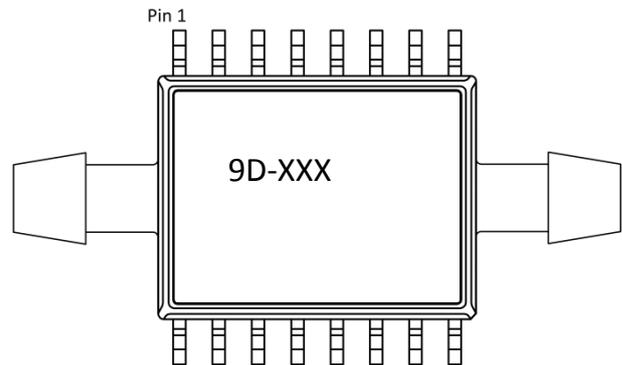
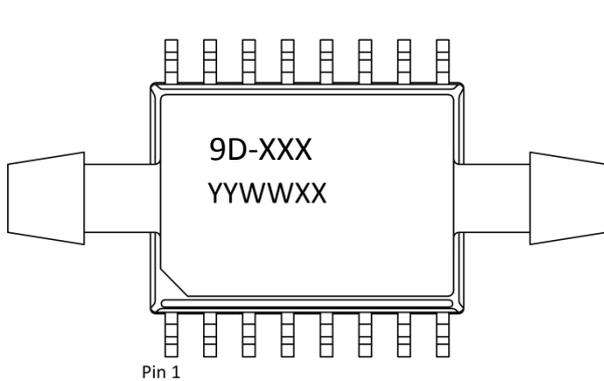
Pin 1



Only in Gage pressure

Pin 1

Pin 1

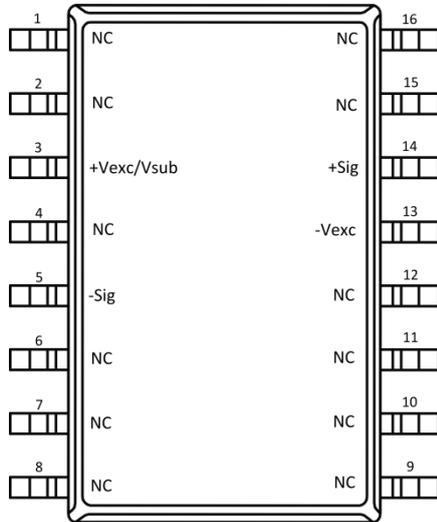


Pin 1

Pin 1

**9G- = Gage, 9D- = Differential**  
**-001 = 0.15 PSI, -006 = 0.6 PSI, -015 = 1.5 PSI**

SM9D Package Pin-Out (Dual Horizontal & Dual Vertical)

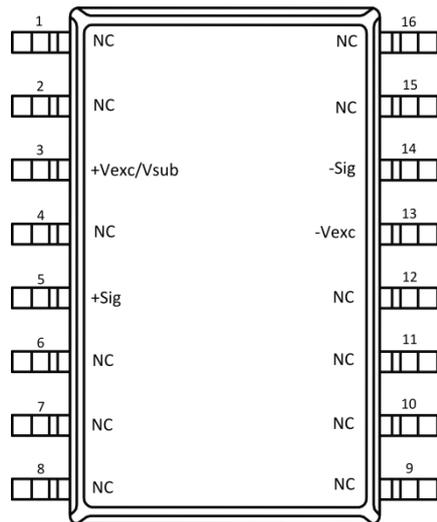


Typical Operation			
PIN	Description	Type	Value
3	+Vexc/Vsub	Power	Up to 5 V
5	-Sig	Analog Out	-
13	-Vexc	Power	Ground
14	+Sig	Analog Out	-

NOTES:

- Do not connect to NC pins
- Applies dual ported vertical and horizontal packages
- Positive pressure applied to the topside of the die [T] is resulting in a positive change in output.

SM9G Package Pin-Out (Single Vertical)



Typical Operation			
PIN	Description	Type	Value
3	+Vexc/Vsub	Power	Up to 5 V
5	+Sig	Analog Out	-
13	-Vexc	Power	Ground
14	-Sig	Analog Out	-

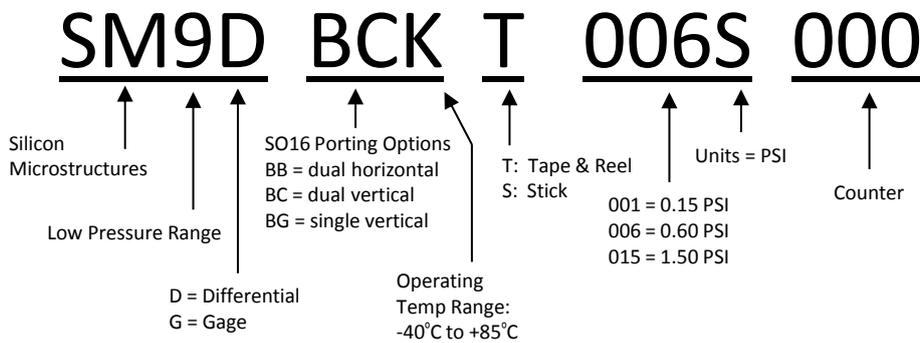
NOTES:

- Do not connect to NC pins
- Applies to single ported vertical package
- Positive pressure applied to the port results in a positive change in output. Pressure is applied to the backside of the die.

**Ordering Information**

Order Code	Pressure Type	Full-Scale Pressure Range	Cap Configuration	Shipping Configuration
SM9D-BCK-T-001S-000	Differential	0.15 PSI	Dual Vertical	Tape & Reel 350 devices per reel
SM9D-BCK-T-006S-000		0.60 PSI		
SM9D-BCK-T-015S-000		1.50 PSI		
SM9D-BBK-T-001S-000	Differential	0.15 PSI	Dual Horizontal	Tape & Reel 500 devices per reel
SM9D-BBK-T-006S-000		0.60 PSI		
SM9D-BBK-T-015S-000		1.50 PSI		
SM9G-BGK-T-001S-000	Gage	0.15 PSI	Single Vertical	Tape & Reel 400 devices per reel
SM9G-BGK-T-006S-000		0.60 PSI		
SM9G-BGK-T-015S-000		1.50 PSI		

**Part Number Legend**



**Qualification Standards**

- REACH compliant
- RoHS compliant
- PFOS/PFOA compliant
- For qualification specifications please contact Sales at sales@si-micro.com



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